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IBM Docket No. FIS920040002US1

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Mukta G. Farooq et al.

Serial No.:

10/711,501

Date:

February 9, 2006

Filed:

September 22, 2004

Group Art Unit:

1725

Title:

SOLDER INTERCONNECTION ARRAY WITH OPTIMAL

MECHANICAL INTEGRITY

DeLIO & PETERSON, LLC

121 Whitney Avenue

New Haven, CT 06510-1241

LETTER TO OFFICIAL DRAFTSMAN

Mail Stop PGPUB Drawings
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Applicants are herewith submitting 9 sheets of Formal Drawings for the approval of the Draftsman.

Please charge the Assignee IBM Corporation Deposit Account No. **09-0458** for any fee related to the acceptance of the attached Formal Drawings. A duplicate copy of this letter is enclosed for that purpose.

I hereby certify that I am depositing the correspondence with the United States mail in an envelope addressed to Mail Commissioner for Patents, P.O. Box 14	Postal Service as first class Stop PGPUB Drawings,
1450.	•
on February 9, 2006	
arol M. Thomas	
Name of person mailing paper	02/09/06
Signature	Date

CERTIFICATE OF MAILING UNDER 37 CFR 1.8

Respectfully submitted,

BY:

Attorney: Kelly M. Nowak Registration No. 47,898

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